



ISES MEMBERSHIP BENEFITS

BE PART OF THE WORLDS LEADING SEMICONDUCTOR ASSOCIATION
DEDICATED EXCLUSIVELY TO END USERS, FOUNDRIES, IC DESIGN,
IDM'S, OSATS & RESEARCH INSTITUTE LEADERS



● CONTACT US

INFO@ISESGLOBAL.COM

ABOUT US

ISES Mission

The International Semiconductor Executive Summits (ISES) is where **leaders connect** with the end goal to **collaborate** and share ideas in a trusted network to establish an effective global semiconductor ecosystem. We provide a unique platform which entails collaboration through global leading executives connecting with peers, partners, and customers to connect ideas share best practices, identify challenges and gain visibility across the global semiconductor industry.



Leadership

ISES is led by an Advisory Board and a set of subsidiary **Task Forces**. These Advisory Board of Directors consist of semiconductor industry executives from acclaimed companies including **Intel, TSMC, Broadcom, MediaTek, Infineon, Vanguard, Ams Osram, Amkor** and many other global leaders who collaborate to support our mission.

Global Executive Network

ISES hosts the highest NPS rating Semiconductor Summits in the World. With a capped audience of 150 leaders in each major region: USA, Europe, Taiwan & China consisting of Participation of Leaders in **Technology, Manufacturing, Operations and R&D**.

Visibility, Intelligence & Events

With absolute leverage of the above, ISES provides its members a platform for collaboration and strategic thought leadership through our hybrid **regional and global events**, dedicated to Advanced Packaging, Memory Manufacturing, Automotive Semiconductors, Power Semiconductors, Market Research and more. Covering strategic technical discussion alongside a commitment to Inclusion & Diversity & Workforce Development initiatives, & a variety of **marketing communications and visibility opportunities**.



INTERNATIONAL
SEMICONDUCTOR
EXECUTIVE SUMMITS



• ISES Advisory Board Members



General Chair

HAMID AZIMI

Corporate VP, Director of Substrate Packaging TD



Deputy General Chair

MARKUS KEIL

VP Global Operations and Member of Executive Board



SUNIL BANWARI

VP Business Development, Advantest Cloud Solutions (ACS)



VINCENT DICAPRIO

VP Advanced Packaging and ICAPS / Head of Business and Corporate Development



JENNIFER ZHAO

GM & EVP for Advanced Optical Sensors Division



CJ HSIEH

COO



XIAOXIN QIU

CEO



MARTIN WEIGERT

VP & GM Industrial Fiber Products Division



CHENYAN ZHENG

Senior Director



YUANYUAN ZHOU

Global Business Director



AMY LEONG

CMO



QINGCHUN ZHANG

Professor



ANDY CHUANG

VP Business Development



FARHAT JAHANGIR

CEO and Co-Founder



VANCE WANG

Formerly VP New Fab Project at GTA



CHANG FU

Advanced Module R&D Dep., Deputy Director



SHIH-CHIEH CHANG

General Director, Electronic and Optoelectronic System Research Laboratories



YAOJIAN LIN

VP, GM of Technology R&D Center



IAN HSU

Director IC Packaging Technology Development



RYAN CHEN

General Manager of Computing and AI Technology Group



AKSHAY SINGH

VP, Advanced Packaging Technology Development



JY ZHANG

Chairman & CEO



JIAN ZHANG

VP Product Test Engineering



EDWARD WEI

Senior Adviser to President



SHU-MING LIU

VP



LUBA TANG

Founder & CEO



TIM YEH

Technical Director of Power BU



JOSEPH CHOU

GM



YONGXIANG WEN

Process Technology Director



YU-PO WANG

VP Corporate R&D Center



ANDREW PENG

Formerly VP BD Greater China at Spin Memory



KEY CHUNG

Advanced Packaging CTO



YC LEE

CEO



CHRIS CHERN

Director, Manufacturing Technology Center



SHAOJUN WEI

Professor



YENS HO

R&D Director



WEI WANG

Assistant President; Director of Strategy Development



GEOFFREY STODDART

Commercial Director



WEIHUA CHENG

COO



SANTOSH KUMAR

Director & Principal Analyst



WEI LI

Chairman



TIANCHUN YE

Secretary General of China Integrated Circuit Innovation Alliance
Academician of the International Eurasian Academy of Sciences
President of IC branch of China Semiconductor Industry Association



• ISES Power Advisory Board Members



ALEX LIDOW

CEO



JIM WITHAM

CEO



RAINER KAESMAIER

Managing Director,
Semiconductors



AVINASH KASHYAP

VP Power Technology



LLEW VAUGHAN EDMUNDS

Senior Director of Marketing



MARCO GIANDALIA

VP IC Design



EDOARDO MERLI

Executive Vice President, Power
Transistor Sub-Group Automotive
and Discrete Group



CHRISTOPHE MALEVILLE

CTO





INTERNATIONAL
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EXECUTIVE SUMMITS



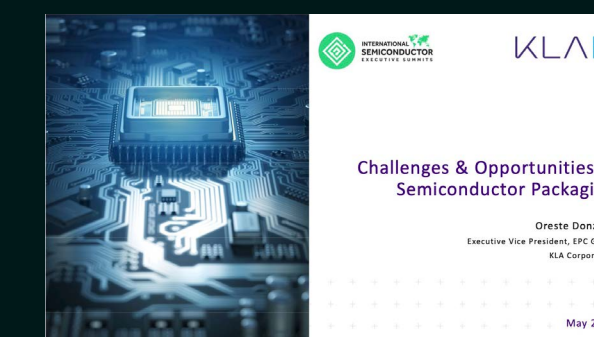
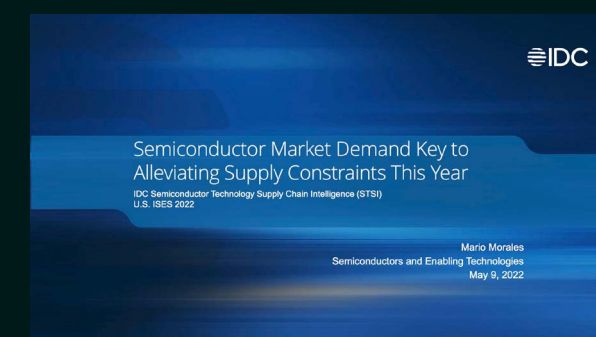
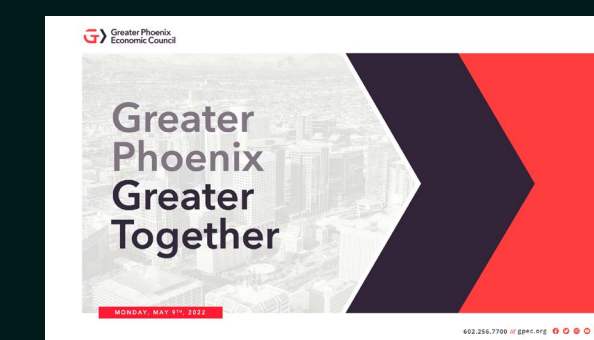
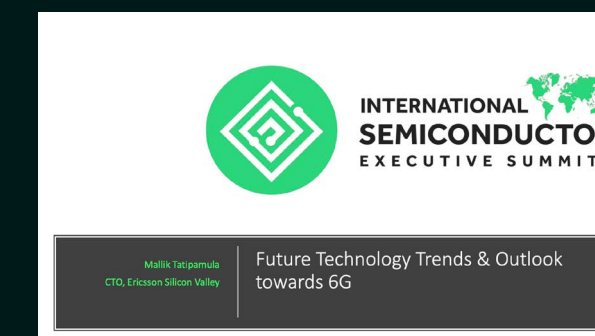
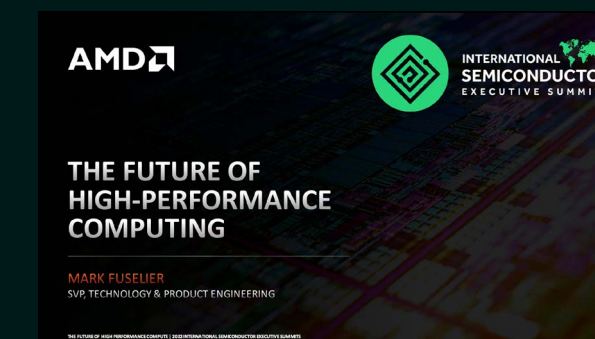
MEMBERSHIP

Reports

1 • ACCESS TO ALL YEAR ROUND ISES PRESENTATIONS AND MARKET UPDATES

ISES Members have access to technology presentations, market reports and our exclusive, specially curated, ISES Presentations and Market Updates as of their membership benefits. All of these Presentations and Market Updates provide information that can be used for corporate strategy, new product development, innovation, research, technology development or marketing. ISES Staff is glad to assist you access all information.

WWW.ISESGLOBAL.COM



2 • ACCESS TO BUSINESS PARTNERS



INTERNATIONAL
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EXECUTIVE SUMMITS

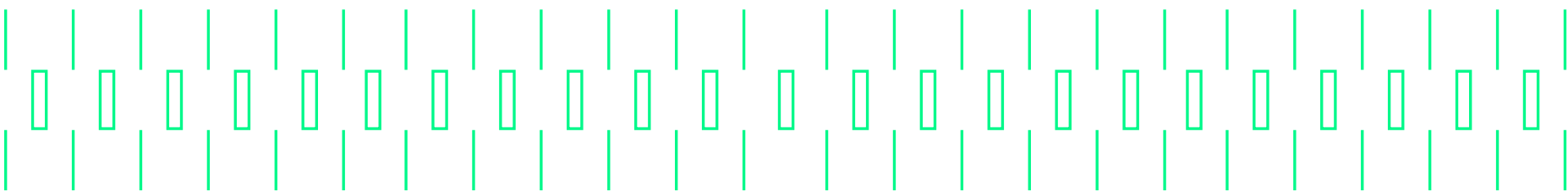
MEMBERSHIP

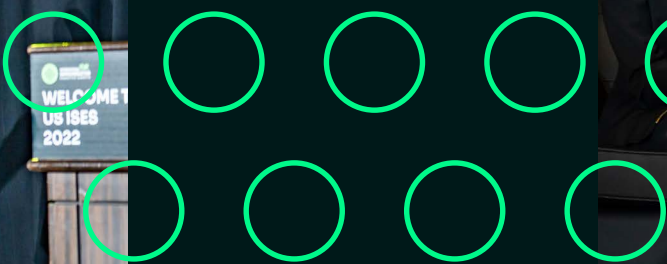
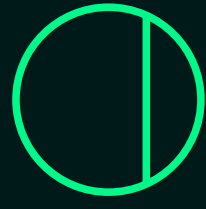
Events

ISES strengthens the connections among its members through our Executive Summits. Designed to meet & discuss challenges and opportunities, and to explore collaboration possibilities. ISES events are by-invitation-only to ensure a relevant audience and highly selective to ensure effective networking. Upon registering our ISES annual Membership, your company will gain market intelligence, brand visibility and discounted member rate | person access to the following ISES 2023 events:

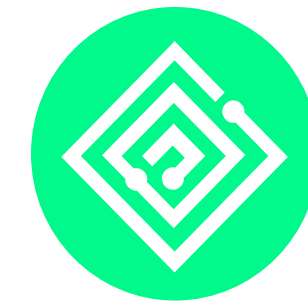
- ISES Middle East 20-21 February
- ISES USA 07-08 March
- ISES Taiwan 04-05 September
- ISES EU Power 14-15 September
- ISES China 17-18 October

View upcoming events on: WWW.ISESGLOBAL.COM





3 . PROMOTION & VISIBILITY FOR YOUR COMPANY



INTERNATIONAL
SEMICONDUCTOR
EXECUTIVE SUMMITS

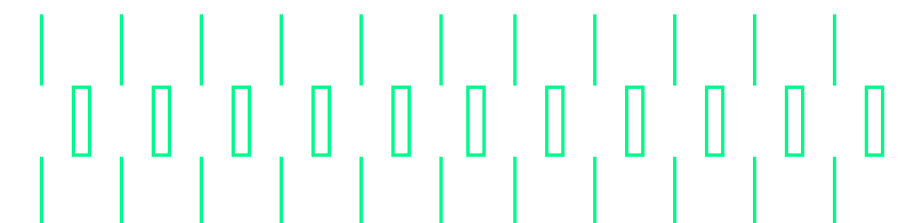


MEMBERSHIP

Promotion

ISES is proud to promote its members. We offer a wide range of services to create more visibility for your company

- Member Product Release via our Mailing List of 10,000+ subscribers
- Media Visibility – We will include your company logo in all general ISES flyer promotions to our 21,000+ followers on LinkedIn Community, plus our event website. We will also include your company logo and ‘about us and company contact info in all ISES event digital program brochure to be accessed on our event apps.
- Member Video Interviews: We will give your In-person event representative the chance to deliver a testimonial with digital logo placement as part of our event video trailers which will be released via mail blast and LinkedIn post after each event.
- Member News – Send us your news and we will share your innovations with our network through social media.
- Sponsorship & Event Participation Opportunities – We offer a special 10% discount on sponsorship packages as an exclusive benefit to our members to increase your company’s visibility at our activities and events



3 . PROMOTION & VISIBILITY FOR YOUR COMPANY

REGIONS COVERED

USA
Taiwan
Europe
Middle East
China

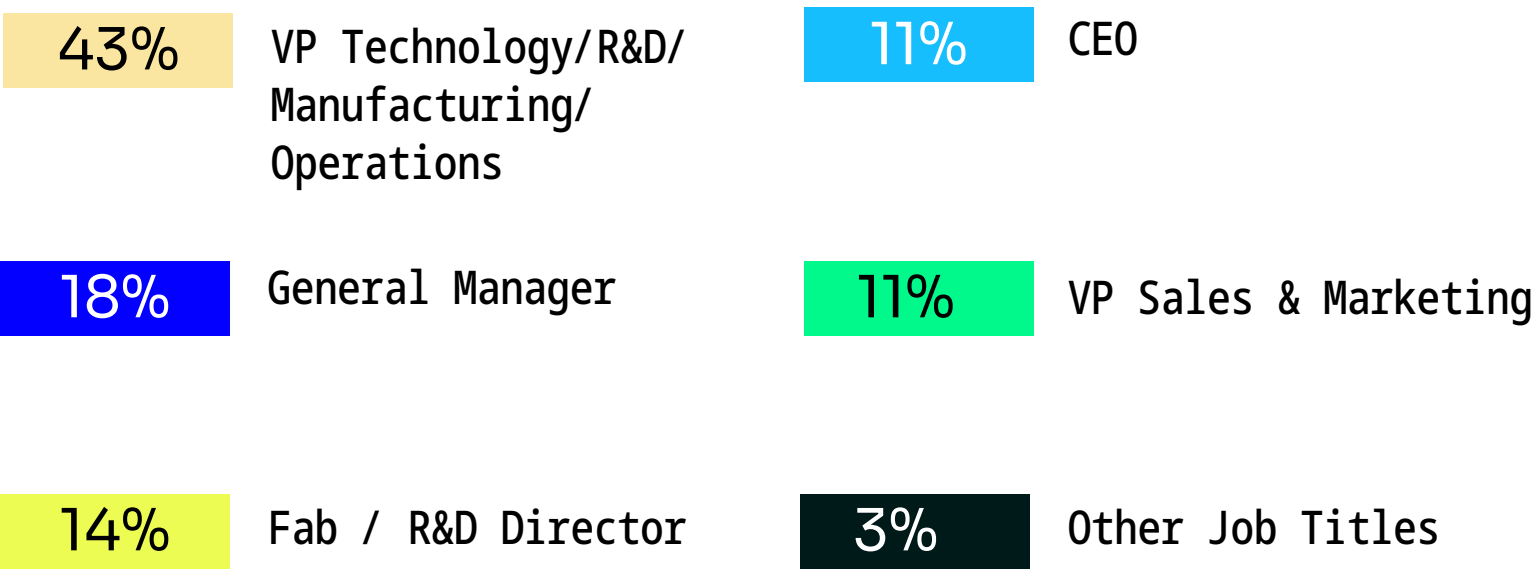
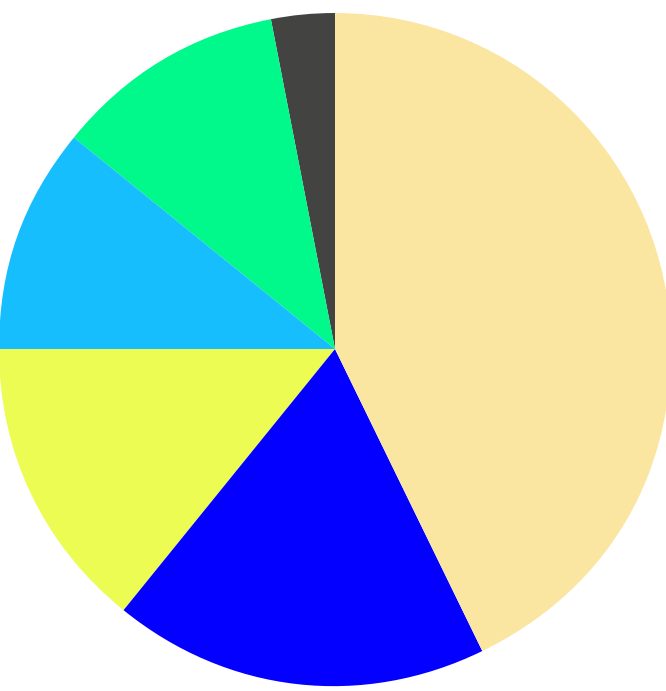


FACTS & FIGURES

778	Attendees
150	Thought Leaders Presentations
72+	Hours of Networking
360	Business Meetings Pre-Arranged
21,000+	Follower on LinkedIn
132	IDM/Foundry (Fabs) Companies in Attendance
29	OSAT Companies in Attendance
157	Fabless Companies in Attendance
61	End User Companies (Automotive/Mobile Phone/Data Servers and etc) in Attendance
62	Equipment & Materials Manufacturing Companies in Attendance

3 . PROMOTION & VISIBILITY FOR YOUR COMPANY

JOB TITLE BREAKDOWN



MEMBERSHIP

Promotion

COMPANY PROFILES

IC Design Houses

IDMs

Foundries

Research Institutes

OSATs

Semiconductor Equipment & Materials Manufacturers

End User: Automotive, Communications, computing, healthcare, transportation, clean energy, and others)

4 • BECOME A MEMBER

Our membership package will include **one** complimentary VIP pass to ALL ISES 2023 in person events for a C/VP/Director Level executive from **one** of the following departments at your company:

- Technology
- Manufacturing
- Engineering
- Operations
- R&D

MEMBER BENEFITS SUMMARY

- All additional event passes will be registered at the lower member rate (please see next page for example)
- First refusal to available speaker slots (subject to Advisory Board approval)
- Access to all on demand recordings of events for your company for the calendar year
- Full year's Membership company logo branding in association with ISES on online and offline materials
- You will also receive priority consideration to join the Advisory Board &/OR Event Task Force positions

4 • BECOME A MEMBER



INTERNATIONAL
SEMICONDUCTOR
EXECUTIVE SUMMITS



● MEMBERSHIP

Member

JOIN TODAY

\$5,000

*Below is an example of membership cost savings when registering an ISES event pass:

- Member Rate per event: \$1,000
- Non-Member rate per event: \$3,000

Please click here to register online:

WWW.ISESGLOBAL.COM/MEMBERSHIP/ 

ISES MIDDLE EAST 2023

● DATE 20-21 February

● LOCATION Oman

ISES EU POWER 2023

● DATE 14-15 September

● LOCATION Italy

MEMS WORLD SUMMIT SINGAPORE 2023

● DATE 07 February

● LOCATION Singapore

ISES USA 2023

● DATE 07-08 March

● LOCATION USA

ISES CHINA 2023

● DATE 17-18 October

● LOCATION China

MEMS WORLD SUMMIT EU 2023

● DATE 30-31 May

● LOCATION Portugal

ISES TAIWAN 2023

● DATE 04-05 September

● LOCATION Taiwan

MEMS WORLD SUMMIT CHINA 2023

● DATE 21-22 November

● LOCATION China

